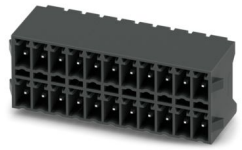
# MCDN 1,5/11-G1-3,5 RNP14THR - PCB header

1953295

https://www.phoenixcontact.com/us/products/1953295

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The figure shows a 10-pos. version with 20 contacts

PCB headers, nominal cross section: 1.5 mm$^2$, color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of potentials: 22, number of rows: 2, number of positions: 11, number of connections: 22, product range: MCDN 1,5/..-G1-RN-THR, pitch: 3.5 mm, mounting: THR soldering / wave soldering, pin layout: Linear pinning, solder pin [P]: 1.4 mm, number of solder pins per potential: 1, plug-in system: COMBICON FMC 1,5 - MCDN 1,5, Pin connector pattern alignment: Standard, locking: Snap-in locking, mounting method: Engagement nose, type of packaging: packed in cardboard, Article with engagement nose. The pin length is 14 mm. User information and design recommendations on Through Hole Reflow Technology can be found at: "Downloads"

## Your advantages

- Designed for integration into the SMT soldering process
- Intuitive locking mechanism prevents accidental disconnection
- Conductor connection on several levels enables higher contact density

## Commercial data

| | |
|---|---|
| Item number | 1953295 |
| Packing unit | 50 pc |
| Minimum order quantity | 50 pc |
| Note | Made to order (non-returnable) |
| Sales key | AA02 |
| Product key | AABTGA |
| GTIN | 4017918918972 |
| Weight per piece (including packing) | 7.32 g |
| Weight per piece (excluding packing) | 6.739 g |
| Customs tariff number | 85366930 |
| Country of origin | DE |

# Technical data

## Product properties

| | |
|---|---|
| Product type | PCB headers |
| Product family | MCDN 1,5/..-G1-RN-THR |
| Product line | COMBICON Connectors S |
| Type | Component suitable for through hole reflow |
| Number of positions | 11 |
| Pitch | 3.5 mm |
| Number of connections | 22 |
| Number of rows | 2 |
| Number of potentials | 22 |
| Mounting type | Engagement nose |
| Pin layout | Linear pinning |
| Solder pins per potential | 1 |

### Fitting of components

| | |
|---|---|
| Partial assembly | No |

## Electrical properties

### Properties

| | |
|---|---|
| Nominal current $I_N$ | 8 A |
| Nominal voltage $U_N$ | 160 V |
| Contact resistance | 2.1 mΩ |
| Rated voltage (III/3) | 160 V |
| Rated surge voltage (III/3) | 2.5 kV |
| Rated voltage (III/2) | 160 V |
| Rated surge voltage (III/2) | 2.5 kV |
| Rated voltage (II/2) | 250 V |
| Rated surge voltage (II/2) | 2.5 kV |

## Mounting

| | |
|---|---|
| Mounting type | THR soldering / wave soldering |
| Pin layout | Linear pinning |

### Processing notes

| | |
|---|---|
| Process | Reflow/wave soldering |
| Moisture Sensitive Level | MSL 1 |
| Classification temperature $T_c$ | 260 °C |
| Solder cycles in the reflow | 3 |

## Material specifications

### Material data - contact

| | |
|---|---|
| Note | WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201 |
| Contact material | Cu alloy |
| Surface characteristics | Tin-plated |
| Metal surface contact area (top layer) | Tin (3 µm - 5 µm Sn) |
| Metal surface contact area (middle layer) | Nickel (1 µm - 3 µm Ni) |
| Metal surface soldering area (top layer) | Tin (3 µm - 5 µm Sn) |
| Metal surface soldering area (middle layer) | Nickel (1 µm - 3 µm Ni) |

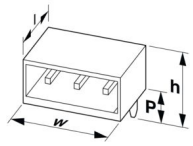
Material data - housing

| | |
|---|---|
| Color (Housing) | black (9005) |
| Insulating material | LCP |
| Insulating material group | IIIa |
| CTI according to IEC 60112 | 175 |
| Flammability rating according to UL 94 | V0 |

## Notes

| | |
|---|---|
| Details for soldering processes | Processing using reflow processes in compliance with IEC 60068-2-58 or DIN EN 61760-1 (latest version)<br>Moisture Sensitive Level (MSL) = 1 according to IPC/JEDEC J-STD-020-C |

## Dimensions

| | |
|---|---|
| Dimensional drawing |  |
| Pitch | 3.5 mm |
| Width [w] | 42.2 mm |
| Height [h] | 16.6 mm |
| Length [l] | 13.3 mm |
| Installed height | 15.2 mm |
| Solder pin length [P] | 1.4 mm |
| Pin dimensions | 0.8 x 0.8 mm |

PCB design

| | |
|---|---|
| Pin spacing | 3.50 mm |
| Hole diameter | 1.4 mm |

## Mechanical tests

Visual inspection

| | |
|---|---|
| Specification | IEC 60512-1-1:2002-02 |
| Result | Test passed |

Dimension check

| | |
|---|---|
| Specification | IEC 60512-1-2:2002-02 |
| Result | Test passed |

Resistance of inscriptions

| | |
|---|---|
| Specification | IEC 60068-2-70:1995-12 |
| Result | Test passed |

Polarization and coding

| | |
|---|---|
| Specification | IEC 60512-13-5:2006-02 |
| Result | Test passed |

Contact holder in insert

| | |
|---|---|
| Specification | IEC 60512-15-1:2008-05 |
| Contact holder in insert<br>Requirements >20 N | Test passed |

Insertion and withdrawal forces

| | |
|---|---|
| Specification | IEC 60512-13-2:2006-02 |
| Result | Test passed |
| No. of cycles | 25 |
| Insertion strength per pos. approx. | 8 N |
| Withdraw strength per pos. approx. | 6 N |

## Electrical tests

Thermal test | Test group C

| | |
|---|---|
| Specification | IEC 60512-5-1:2002-02 |
| Tested number of positions | 20 |

Insulation resistance

| | |
|---|---|
| Specification | IEC 60512-3-1:2002-02 |
| Insulation resistance, neighboring positions | > 5 MΩ |

Air clearances and creepage distances |

| | |
|---|---|
| Specification | IEC 60664-1:2007-04 |
| Insulating material group | IIIa |
| Comparative tracking index (IEC 60112) | CTI 175 |
| Rated insulation voltage (III/3) | 160 V |
| Rated surge voltage (III/3) | 2.5 kV |
| minimum clearance value - non-homogenous field (III/3) | 1.5 mm |
| minimum creepage distance (III/3) | 2.5 mm |
| Rated insulation voltage (III/2) | 160 V |
| Rated surge voltage (III/2) | 2.5 kV |
| minimum clearance value - non-homogenous field (III/2) | 1.5 mm |
| minimum creepage distance (III/2) | 1.6 mm |
| Rated insulation voltage (II/2) | 250 V |
| Rated surge voltage (II/2) | 2.5 kV |
| minimum clearance value - non-homogenous field (II/2) | 1.5 mm |

| | |
|---|---|
| minimum creepage distance (II/2) | 2.5 mm |

## Environmental and real-life conditions

### Durability test

| | |
|---|---|
| Specification | IEC 60512-9-1:2010-03 |
| Impulse withstand voltage at sea level | 2.95 kV |
| Contact resistance $R_1$ | 2.1 mΩ |
| Contact resistance $R_2$ | 2.4 mΩ |
| Insertion/withdrawal cycles | 25 |
| Insulation resistance, neighboring positions | > 5 MΩ |

### Climatic test

| | |
|---|---|
| Specification | ISO 6988:1985-02 |
| Corrosive stress | 0.2 $dm^3$ $SO_2$ on 300 $dm^3$/40 °C/1 cycle |
| Thermal stress | 100 °C/168 h |
| Power-frequency withstand voltage | 1.39 kV |

### Vibration test

| | |
|---|---|
| Specification | IEC 60068-2-6:2007-12 |
| Frequency | 10 - 150 - 10 Hz |
| Sweep speed | 1 octave/min |
| Amplitude | 0.35 mm (10 Hz ... 60.1 Hz) |
| Acceleration | 5g (60.1 Hz ... 150 Hz) |
| Test duration per axis | 2.5 h |
| Test directions | X-, Y- and Z-axis |

### Ambient conditions

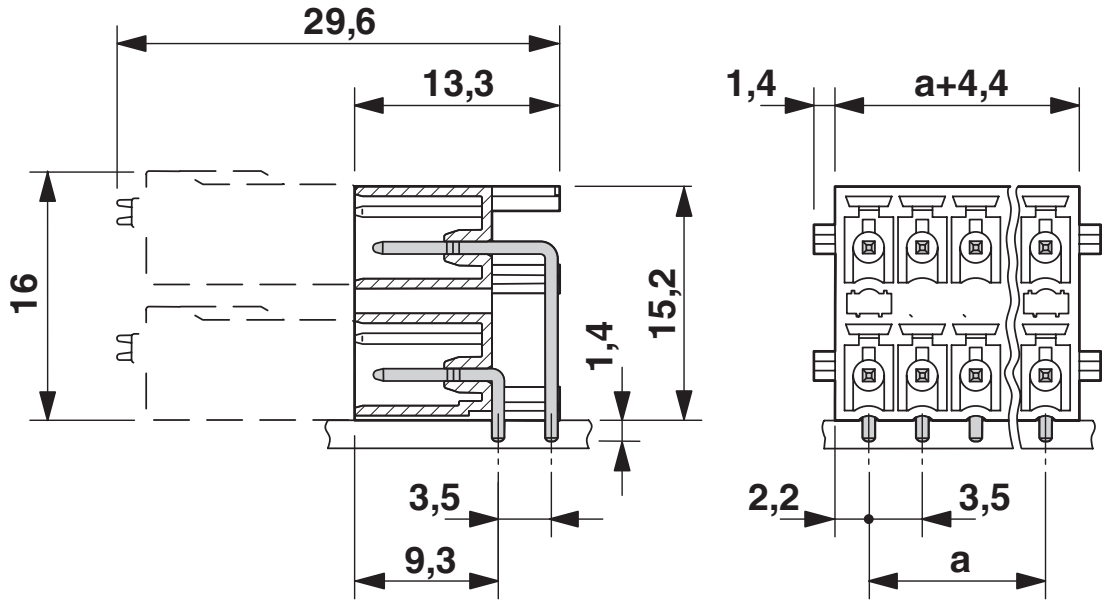
| | |
|---|---|
| Ambient temperature (storage/transport) | -40 °C ... 70 °C |
| Relative humidity (storage/transport) | 30 % ... 70 % |
| Ambient temperature (assembly) | -5 °C ... 100 °C |
| Ambient temperature (operation) | -40 °C ... 100 °C (dependent on the derating curve) |

## Packaging specifications

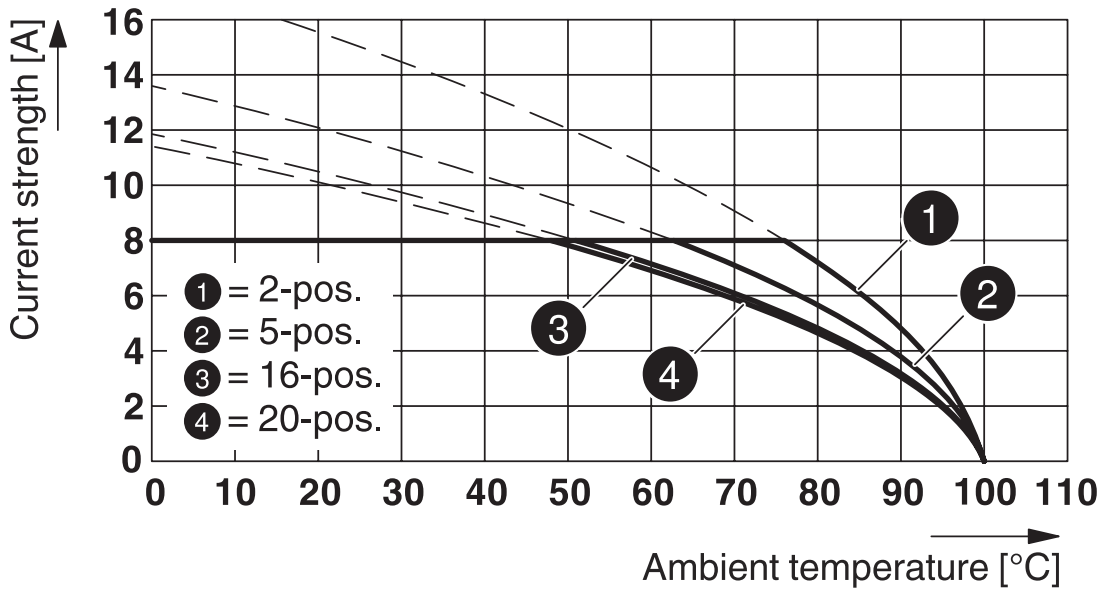
| | |
|---|---|
| Type of packaging | packed in cardboard |

## Drawings

Dimensional drawing

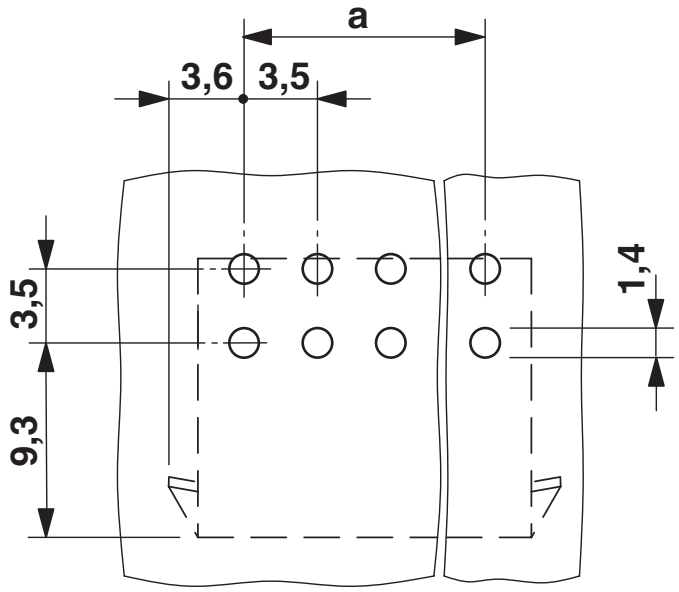



Diagram




Type: FMC 1,5/...-ST-3,5-RF with MCDN 1,5/...-G1-3,5 RNP..THR

Drilling plan/solder pad geometry




*) ≤ 8-pos. = 1.3 / > 8-pos. = 1.4

## Approvals

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1953295

**cULus Recognized**
Approval ID: E60425-20110128

| | Nominal voltage $U_N$ | Nominal current $I_N$ | Cross section AWG | Cross section $mm^2$ |
|---|---|---|---|---|
| B | | | | |
| | 150 V | 8 A | - | - |
| D | | | | |
| | 150 V | 8 A | - | - |

**VDE Zeichengenehmigung**
Approval ID: 40011723

| | Nominal voltage $U_N$ | Nominal current $I_N$ | Cross section AWG | Cross section $mm^2$ |
|---|---|---|---|---|
| keine | | | | |
| | 160 V | 8 A | - | - |

## Classifications

### ECLASS

| | |
|---|---|
| ECLASS-13.0 | 27460201 |
| ECLASS-15.0 | 27460201 |

### ETIM

| | |
|---|---|
| ETIM 10.0 | EC002637 |

### UNSPSC

| | |
|---|---|
| UNSPSC 21.0 | 39121400 |

## Environmental product compliance

EU RoHS

| | |
|---|---|
| Fulfills EU RoHS substance requirements | Yes, No exemptions |

China RoHS

| | |
|---|---|
| Environment friendly use period (EFUP) | EFUP-E |
| | No hazardous substances above the limits |

EU REACH SVHC

| | |
|---|---|
| REACH candidate substance (CAS No.) | No substance above 0.1 wt% |


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